



### List of New Course(s) Introduced

**Department** : **Electronics and Communication Engineering**

**Programme Name** : **B.Tech.**

**Academic Year** : **2018-19**

### List of New Course(s) Introduced

Sr. No.	Course Code	Name of the Course
01.	EC7TPC12	Microwave Engineering
02.	EC7TPC13	Wireless Mobile Communication
03.	EC7TPE05	Advance Hardware Design
04.	EC7TPE06	Power Electronics
05.	EC7TOE31	Wireless Sensor Network
06.	EC7TOE32	Information theory and coding
07.	EC7TOE33	Nanotechnology
08.	EC7TOE34	Optical instrumentation and measurement
09.	EC7TOE35	Neural Network and Fuzzy Logic
10.	EC8TPC14	Radar and Satellite Engineering
11.	EC8TPC15	Optical Fiber Communication
12.	EC8TPE07	VLSI Fabrication Methodology
13.	EC8TOE41	Basic building block of Microwave Engineering
14.	EC8TOE42	Principle of Management
15.	EC8TOE43	Mobile Computing
16.	EC8TOE44	Embedded System
17.	EC8TOE45	Advanced Power Electronics

वर्गभाष्य (इले. एव संचार अभियंत्रिकी)  
H.O.D. (Elect. & Comm. Engineering)  
प्रौद्योगिकी संस्थान  
Institute of Technology  
गु. घा. वि., बिलासपुर (छ.ग.)  
G. G. V. Bilaspur (C.G.)

## Minutes of Meetings (MoM) of Board of Studies (BoS)

<b>Academic Year: 2018-19</b>	
<b>School</b>	<b>: <i>School of Studies of Engineering and Technology</i></b>
<b>Department</b>	<b>: <i>Electronics and Communication Engineering</i></b>
<b>Date and Time</b>	<b>: <i>May 15, 2018 - 11:00 AM</i></b>
<b>Venue</b>	<b>: <i>E-Class Room</i></b>

The scheduled meeting of member of Board of Studies (BoS) of Department of Electronics and Communication Engineering, School of Studies of Engineering and Technology, Guru Ghasidas Vishwavidyalaya, Bilaspur was held to design and discuss the B. Tech. Final year (VII and VIII semesters) scheme and syllabi.

The following members were present in the meeting:

1. Prof. Shrish Verma (External Expert Member BoS, Dept. of ECE, NIT Raipur)
2. Mr. Nipun Kumar Mishra (HOD, Assistant Prof., Dept. of ECE-cum Chairman, BOS)
3. Mrs. Pragati Patharia (Member BoS, Assistant Professor, Dept. of ECE)
4. Dr. P.S. Shrivastava (Invited Member, Assistant Professor, Dept. of ECE)
5. Mrs. Beaulah Nath (Invited Member, Assistant Professor, Dept. of ECE)
6. Mr. Shrawan K. Patel (Invited Member, Assistant Professor, Dept. of ECE)
7. Dr. Soma Das (Invited Member, Assistant Professor, Dept. of ECE)
8. Mr. Sumit Kumar Gupta (Invited Member, Assistant Professor, Dept. of ECE)
9. Mrs. Sugandha Yadav (Invited Member, Assistant Professor Ad-Hoc, Dept. of ECE)
10. Mr. R.K Jatav Invited Member, Assistant Professor Ad-Hoc, Dept. of ECE)
11. Mr. T.K Sahu Invited Member, Assistant Professor Ad-Hoc, Dept. of ECE)

Following points were discussed during the meeting

1. CBCS based evaluation scheme of 7<sup>th</sup> and 8<sup>th</sup> semester was discussed and finalized.
2. Courses of 7<sup>th</sup> and 8<sup>th</sup> semester are discussed one by one and the changes have been incorporated as per the valuable suggestions of Expert member.


The following new courses were introduced in the of B. Tech. Final year (VII and VIII Semesters):

- ❖ Microwave Engineering (EC7TPC12)
- ❖ Wireless Mobile Communication (EC7TPC13)
- ❖ Advance Hardware Design (EC7TPE05)
- ❖ Power Electronics (EC7TPE06)
- ❖ Wireless Sensor Network (EC7TOE31)
- ❖ Information theory and coding (EC7TOE32)
- ❖ Nanotechnology (EC7TOE33)
- ❖ Optical instrumentation and measurement (EC7TOE34)
- ❖ Neural Network and Fuzzy Logic (EC7TOE35)
- ❖ Radar and Satellite Engineering (EC8TPC14)
- ❖ Optical Fiber Communication (EC8TPC15)

- ❖ VLSI Fabrication Methodology (EC8TPE07)
- ❖ Basic building block of Microwave Engineering (EC8TOE41)
- ❖ Principle of Management (EC8TOE42)
- ❖ Mobile Computing (EC8TOE43)
- ❖ Embedded System (EC8TOE44)
- ❖ Advanced Power Electronics (EC8TOE45)

[Consent taken by Email attached]

Prof. Shrish Verma  
(External Subject Expert)



15/05/18

Mr. Nipun Kumar Mishra  
(Chairman, BOS)

[Consent taken by Email attached]

Mr. Avinash Singh Verma  
(Industrial Expert)



15/05/18

Mrs. Pragati Patharia  
(Member, BOS)



## Scheme and Syllabus

**ELECTRONICS & COMMUNICATION ENGINEERING**  
**INSTITUTE OF TECHNOLOGY**

Effective From 2018-19 (CBCS)

**GURU GHASIDAS CENTRAL UNIVERSITY BILASPUR**

**SCHEME OF B.Tech. VII<sup>th</sup> SEMESTER (CBCS)**  
**ELECTRONICS & COMMUNICATION ENGINEERING**

### VII<sup>th</sup> SEMESTER

S.No :	Sub Code	Subject	Periods			Evaluation Scheme			Credit
			L	T	P	IA	ESE	Sub Total	
1.	EC7TPC12	Microwave Engineering	3	1		40	60	100	4
2.	EC7TPC13	Wireless Mobile Communication	3	1		40	60	100	4
3.	EC7TPE05	Advance Hardware Design	3	0		40	60	100	3
4.	EC7TPE06	Power Electronics	3	0		40	60	100	3
5.	EC7TOE31- EC5TOE35	1. Wireless sensor network , 2 Information theory and coding 3.Nanotechnology 4.Optical instrumentation and measurement, 5. Neural network and fuzzy logic	3	0		40	60	100	3
		PRACTICAL							
6.	EC7TPPC12	Microwave Engineering			3	30	20	50	2
7.	EC7TPPE05	Comprehensive Viva			3	30	20	50	2
8.	EC7PSP02	Project-I			6	30	20	50	3
			15	2	12	290	360	650	24

L: Lecture, T: Tutorial, P: Practical, IA: Internal Assessment, MSE: Mid Semester Exam, ESE: End Semester Exam.



ELECTRONICS & COMMUNICATION ENGINEERING

Effective From 2018-19 (CBCS)

**GURU GHASIDAS CENTRAL UNIVERSITY BILASPUR**

**SCHEME OF B.Tech. VIII<sup>th</sup> SEMESTER (CBCS)**  
ELECTRONICS & COMMUNICATION ENGINEERING

**VIII<sup>th</sup> SEMESTER**

S.No :	Sub Code	Subject	Periods			Evaluation Scheme			Credit
			L	T	P	IA	ESE	Sub Total	
1.	EC8TPC14	Radar and Satellite Engineering	3	1		40	60	100	4
2.	EC8TPC15	Optical Fiber Communication	3	1		40	60	100	4
3.	EC8TPE07	VLSI Fabrication Methodology	3	0		40	60	100	3
5.	EC8TOE41- EC8TOE45	41. Basic building block of Microwave Engineering 42. Principle of Management 43 Mobile Computing 44. Embedded System 45. Advanced Power Electronics	3	0		40	60	100	3
		PRACTICAL							
6.	EC8TPPC15	Optical Fiber Communication			3	30	20	50	2
7.	EC8TPPC16	Advanced RF and Microwave Design lab			3	30	20	50	2
8.	EC8TPSP03	Project-II			8	30	20	50	4
9	EC8TPSP04	Comprehensive Viva				30	20	50	2
			12	2	14	280	320	600	24

L: Lecture, T: Tutorial, P: Practical, IA: Internal Assessment, MSE: Mid Semester Exam, ESE: End Semester Exam.





**ELECTRONICS & COMMUNICATION ENGINEERING**

Effective From 2018-19 (CBCS)

Sub Code	L	T	P	Duration	IA	ESE	Credits
EC7TPC12	3	1		3 hours	40	60	4

## Microwave Engineering

**Course Objectives :** Students will try to learn:

1. To understand Analysis of Waveguides and gain complete knowledge about Microwave Components.
2. Design of Impedance Matching and Tuning using lumped and distributed elements for network.
3. To Analysis and study characteristics of microwave tube Generators and Amplifiers.
4. To Analysis and study characteristics of microwave Semiconductor of detector, switch, generator and amplifier.

### UNIT – I

**Microwave Waveguides:** Introduction, Types of waveguides, TE and TM modes in Rectangular wave guide, Dominant mode, Various field components of TE and TM modes, Cut off frequency of a wave guide, Phase velocity, Group velocity, Guide wave length, Wave impedance, Power transmission in rectangular wave guide, TE and TM modes for Circular wave guide.

### UNIT –II

**Microwave tubes and Measurements:** Introduction, High frequency limitations of conventional tubes, Two cavity Klystron amplifier, Bunching process, Applegate diagram, Analysis of two cavity Klystron, Reflex Klystron: Performance characteristics, Travelling Wave Tube (TWT): Constructional features and operating principle of TWT, Magnetron: Construction and operating principle of cavity magnetron, Analysis of Cylindrical Magnetron, Mode jumping.

### UNIT –III

**Solid State Microwave Devices:** Introduction to Microwave Transistors, MESFETs Varactor Diode, Parametric Amplifiers, Masers, PIN diode; Schottky Barrier Diodes, Tunnel Diode, Transferred Electron Devices: Gunn Effect, Gunn diode as an amplifier & Oscillator, Avalanche transit time devices: IMPATT diode, TRAPATT diode, BARITT diode.

### UNIT –IV

**Microwave Network Analysis:** Scattering Matrix, Properties of Scattering Matrix, Microwave T junctions: H-plane Tee, E-plane Tee, Magic Tee junction and its applications; Directional Couplers: Introduction and Scattering Matrix of a Directional Coupler; Rate Race Junction, Isolator, Circulator, Attenuator, Phase Shifters.



**ELECTRONICS & COMMUNICATION ENGINEERING**

Effective From 2018-19 (CBCS)

Sub Code	L	T	P	Duration	IA	ESE	Credits
EC7TPC13	3	1		3 hours	40	60	4

**WIRELESS & MOBILE COMMUNICATION**

**Course Objectives:** Students will try to learn:

1. To study the concept of Mobile radio propagation, cellular system design.
2. To understand mobile technologies like GSM and CDMA.
3. To know the mobile communication evolution of 2G, 3G and beyond in brief.

**UNIT - I**

**Introduction to Wireless Communication System:** Evolution mobile communications, Mobile radio around the world, Types of Wireless communication system, comparison of Common wireless system, Trend in Cellular radio and personal Communication. Second generation Cellular Networks, Third Generation (3G) Wireless Networks, Wireless Local Loop(WLL), Bluetooth and Personal Area Networks. The Cellular Concept-System design Fundamentals: Cellular System, Hexagonal geometry cell and frequency reuse concept, channel assignment strategies, Distance to frequency reuse ratio, channel & Co-channel interference reduction factor, S/I ratio consideration and calculation for minimum Co-channel and adjacent interference, Handoff strategies, Umbrella Cell Concept, Trunking and Grade Of Service(GOS), Improving Coverage & Capacity in cellular System-splitting, cell sectorization, Repeaters, Micro cell zone concept.

**UNIT – II**

**Mobile Radio Propagation: Large Scale Path Loss :** Free space propagation model, The three basic propagation Mechanism: reflection, diffraction, scattering, Practical link budget design, Outdoor Propagation models, Indoor propagation models, Small scale Multipath propagation, Impulse response model of a Multipath Channel, Small scale Multipath measurements, parameters of Mobile multipath channels, types of small scale fading, Rayleigh and Ricean Distributions, Statistical for models multipath fading channels and diversity techniques in brief.

**UNIT-III**

**Modulation Techniques:** Orthogonal Frequency Division Multiplexing, Performance of Digital Modulation in Slow-Flat Fading Channels and Frequency Selective Mobile Channels. Equalization: Survey of Equalization Techniques, Linear Equalization, Non-linear Equalization, Algorithms for Adaptive Equalization.

**UNIT – IV**

**Multiple Access Techniques for Wireless Communication:** Introduction, FDMA, TDMA, CDMA: DS-SS, FH-SS, space division multiple access, packet radio, capacity of a cellular systems.



**ELECTRONICS & COMMUNICATION ENGINEERING**

Effective From 2018-19 (CBCS)

Sub Code	L	T	P	Duration	IA	ESE	Credits
EC7TPE05	3			3 hours	40	60	3

**ADVANCE HARDWARE DESIGN**

**CourseObjective:** Students will try to learn:

1. The architecture and operation of typical microprocessors and microcontrollers.
2. To familiarize the students with the programming and interfacing of microprocessors and microcontrollers.
3. To provide strong foundation for designing real world applications using microprocessors and microcontrollers

**UNIT – I**

**Microprocessor Applications: Interfacing** of LEDs, Common cathode and common anode connection, interfacing of keyboards, interfacing of seven segment device, Case studies of microprocessor based systems.

**UNIT –II**

Review of Evolution of Advanced Microprocessors:8086, 8088, 186/286/386/486/Pentium. RISC & CISC processor. Serial I/O & Data communication: RS 232c etc., Various BUS Standards, Introduction to ISA, EISA (82350 chip set).

**UNIT –III**

**Microcontroller:** Introduction to 8051 microcontroller, Architecture of 8051 microcontroller, Microcontroller resources, ALU, Special function register, Memory Organization, Internal and external memory. Assembly language programming.

**UNIT –IV**

**Interrupt and Timer/Counter:** Interrupts, Types of interrupt Timers/Counters, Programming external Hardware Interrupt, Interrupt priority in 8051.

**UNIT –VEmbedded system:** Introduction to Embedded system, Properties of embedded system, Working of embedded system, challenges of embedded systems





ELECTRONICS & COMMUNICATION ENGINEERING

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Sub Code	<i>L</i>	<i>T</i>	<i>P</i>	<i>Duration</i>	<i>IA</i>	<i>ESE</i>	<i>Credits</i>
<i>EC7TPE06</i>	<i>3</i>			<i>3 hours</i>	<i>40</i>	<i>60</i>	<i>3</i>

## Power Electronics

**Course Objectives:** Students will try to learn:

1. The basic theory of power semiconductor devices and passive components, their practical applications in power electronics.
2. To familiarize students to the principle of operation, design and synthesis of different power conversion circuits and their applications.
3. To provide strong foundation for further study of power electronic circuits and systems.

### UNIT – I

**Introduction to Power Electronics:-** Introduction, Power electronics versus Linear Electronics, scope and applications. Overview of Power semiconductor switches.

Thyristor characteristics, Two transistor model of Thyristor. Thyristor Turn-On di/dt protection, dv/dt protection, Thyristor Turn-On, Series and parallel operation of Thyristor, Various Thyristor Commutation Techniques.

### UNIT – II

**Controlled Rectifiers:-** Introduction, Principle of Phase controlled converter operation, Single Phase semi converter with RL load, Single Phase full converter with RL load, Single phase dual converters, Three phase half wave converters, Three phase semi converters with RL load, Three phase full converter with RL load, Three phase Dual converters, Power factor improvements, Excitation angle control, PWM control, Sinusoidal Pulse Width Modulation

### UNIT – III

**Inverters:** Single Phase - Half and Full Bridge Inverter with R and RL Load, fourier analysis single phase inverter output voltage. Performance parameters, Voltage control of single phase inverters, 3-Phase Bridge Inverters, PWM inverters.

### UNIT – IV

**DC Choppers:-** Introduction, Principle of Step-Down operation, Step Down chopper with RL load, Principle of Step-Up operation, Performance parameters, Switch mode regulators, **Thyristor based chopper circuits:** Impulse commutated choppers, Impulse commutated three thyristor chopper, Resonant pulse choppers.



ELECTRONICS & COMMUNICATION ENGINEERING

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Sub Code	L	T	P	Duration	IA	ESE	Credits
EC7TOE31	3			3 hours	40	60	3

## WIRELESS SENSOR NETWORK

**Course Objectives:** Students will try to learn:

1. To Understand the basic WSN technology and supporting protocols, with emphasis placed on standardization basic sensor systems and provide a survey of sensor technology
2. Understand the medium access control protocols and address physical layer issues
3. Learn key routing protocols for sensor networks and main design issues
4. Learn transport layer protocols for sensor networks, and design requirements
5. Understand the Sensor management, sensor network middleware, operating systems.

### UNIT- I

Wireless Sensor Network: Introduction, Architecture, Hardware and Software used in Wireless Sensor Network.

### UNIT- II

Sensor network application: Motion monitoring, Environmental monitoring, Generic Architecture, Sensor network Evolution.

### UNIT- III

Wireless Sensor Network : Design , Goals and Issues , Sensor deployment, Scheduling and coverage issues, self configuration and topology control, Querying, data collection and processing, Collaborative information processing and group connectivity.

### UNIT- IV

Wireless Sensor Routing Protocols: Data Centric, Hierarchical, Location based, Energy efficient routing,

### UNIT- V

Sensor Network Challenges – Miniaturization, power management, scalability, remote management, usability, standardization and security, System Challenges- Tiny OS, Network Sensor Platforms.

### SUGGESTED BOOKS & REFERENCE:-

1. *Building Wireless Sensor Networks* by Robert Faludi Binding: Paperback Publisher: O'reilly Released: 2011



Sub Code	L	T	P	Duration	IA	ESE	Credits
EC7TOE32	3	0		3 hours	40	60	3

## INFORMATION THEORY AND CODING

**Course Objectives:** Student will try to learn:

1. To equip students with the basic understanding of the fundamental concept of entropy and information as they are used in communications.
2. To enhance knowledge of probabilities, entropy, measures of information.
3. To guide the student through the implications and consequences of fundamental theories and laws of information theory and coding theory with reference to the application in modern communication and computer systems

**UNIT 1:** Uncertainty, information, Entropy, Joint Entropy and Conditional Entropy, Relative Entropy and Mutual Information, Relationship between Entropy and Mutual Information, Chain Rules for Entropy, Entropy of binary memoryless source and its extension to discrete memoryless source, source coding theorem, data compression, Prefix coding, Huffman coding, Lempel-Ziv coding, Source with memory and its entropy.

**UNIT 2:** Introduction to information Channels, Communication Channels, Continuous channels, discrete communication channels. Discrete memory less Channels, Channel Capacity, Channel coding theorem and its application to BSC, Shannon's theorem on channel capacity.

**UNIT 3:** Block Code and its Properties, Kraft-McMillan Equality and Compact Codes, Encoding of the source output, Shannon's encoding algorithm, Coding Strategies, Shannon-Fano-Elias Coding and Introduction to Arithmetic Coding.

**UNIT 4:** Introduction to Error Control Coding, Linear block codes, Systematic codes and its encoding circuit, Syndrome and error detection, minimum distance, error detecting and correcting capabilities of block code, decoding circuit.

**UNIT 5:** Basic properties of Cyclic codes, Generator and parity check matrix of cyclic codes, Introduction to convolution code, its construction and Viterbi algorithm for maximum likelihood decoding.



**ELECTRONICS & COMMUNICATION ENGINEERING**

Effective From 2018-19 (CBCS)

Sub Code	L	T	P	Duration	IA	ESE	Credits
EC7TOE33	3	0		3 hours	40	60	3

## **NANOTECHNOLOGY**

**Course Objectives:** Student will try to learn:

1. To foundational knowledge of the Nanoscience and related fields.
2. To make the students acquire an understanding the Nanoscience and Applications
3. To help them understand in broad outline of Nanoscience and Nanotechnology.

### **UNIT-1**

Introduction to Nanotechnology: Essence of Nanotechnology, Nano in daily life, Brief account of nano applications, Properties of nano materials, Properties at nanoscale (optical, electronic and magnetic), Metal nano clusters, Semiconductor nano particles.

### **UNIT-2**

Nano Materials-Metal and Semiconductor Nanomaterials, Quantum Dots, Wells and Wires, Molecule to bulk transitions.

### **UNIT-3**

Carbon Nano Structures :Introduction, Carbon molecules, Carbon clusters, Carbon nanotubes, Applications of carbon nanotubes.

### **UNIT-4**

Synthesis Of Nanomaterials :Top-down (Nanolithography, CVD), Bottom-up (Sol-gel processing, chemical synthesis). Wet Deposition techniques, Self-assembly (Supramolecular approach), Molecular design and modeling.

### **UNIT-5**

Application: Solar energy conversion and catalysis, Molecular electronics and printed electronics Nanoelectronics, Polymers with a special architecture, Liquid crystalline systems, Linear and nonlinear optical and electrooptical properties, Applications in displays and other devices, Advanced organic materials for data storage, Photonics, Plasmonics, Chemical and biosensors, Nanomedicine and Nanobiotechnology.

### **SUGGESTED BOOKS & REFERENCE:-**

1. *Nanotechnology* by Richard Booker, Earl Boysen, Wiley Publishing Inc., 2006.
2. *Introduction to Nanotechnology* by Charles P. Poole Jr., Frank J. Owens, John Wiley & Sons Publications, 2003.
3. Hari Singh Nalwa, "Nanostructured Materials and Nanotechnology", Academic Press, 2002





Sub Code	L	T	P	Duration	IA	ESE	Credits
EC7TOE34	3	0		3 hours	40	60	3

## Optical Instrumentation & Measurements

**Course Objectives:** Student will try to learn:

1. The different types of optical sources and their characteristics.
2. The different aspects of optical instrumentation.
3. Study about different optical sensors.
4. Different methods to calculate the various parameter for optical fiber.

**Unit 1. Light Sources:** Introduction, LEDs, power, efficiency, types and structures of LEDs, characteristics and modulation, driver circuits, semiconductor lasers diodes, modulation characteristics, driving circuitry.

**Unit 2. Optical Instrument:** Optical time domain reflectometer, optical low coherence reflectometer, optical power and energy meter, monochromator, CCD, optical spectrum analyzer, ellipsometer, Transducers, Lock-in-Amplifier, Box car averager.

**Unit 3. Fiber optic components and devices:** Direction couplers, beam splitters, switches modulations, connectors, couplers, polarizers, polarization controllers, amplifiers, fiber lasers, reflectors, wavelength filters, polarizing beam splitters, wavelength division multiplexers, fiber optic isolators etc.

**Unit 4. Fibre optic sensors:** Pressure, temperature, strain, magnetic and electric field sensors based on the characteristics like intensity, phase, polarization, frequency and wavelength of light wave.

**Unit 5. Measurements methods in optical fibre:** General experimental consideration, measurement of refractive index profile, numerical aperture, attenuation, pulse dispersion and bandwidth. Cut off wavelength, mode field diameter and birefringence of single mode fiber.

### SUGGESTED BOOKS & REFERENCE:-

1. B. P. Pal : *Fundamentals of Fibre Optics in Telecommunication and Sensor Systems*, New Age, New Delhi, 1992.
2. A. K. Ghatak and K. Thyagarajan, *Introduction to Fiber Optics*, Cambridge, 1998.
3. S.M. Senior : *Optical Fibre Communication: Principles and Practice*, PHI, New Delhi, 2002.
4. A.K. Ghatak, M.R. Shenoy : *Fibre Optics Measurements*, Viva, New Delhi, 1995.

**Course Outcome:** After the successful completion of the course the students will be able to:

1. explain the basic concepts of optical transmitting and receiving



ELECTRONICS & COMMUNICATION ENGINEERING

Effective From 2018-19 (CBCS)

## NEURAL NETWORK & FUZZY LOGIC SYSTEM

**Course Objectives:** Students will try to learn:

1. Concepts and understanding of artificial neural networks
2. Fuzzy logic basic theory and algorithm formulation
3. To solve real world problems.

### UNIT-I

**Introduction to ANS Technology:** Elementary Neurophysiology, Models of a Neuron, Neural Networks viewed as directed graphs, Feedback, from neurons to ANS, Artificial Intelligence and Neural Networks.

### UNIT-II

**Learning and Training:** Hebbian, Memory based, Competitive, Error-Correction Learning, Credit Assignment Problem: Supervised and Unsupervised learning, Memory models, Recall and Adaptation. Network Architectures, Single-layered Feed-forward Networks, Multi-layered Feedforward Networks, Recurrent Networks, Topologies.

**UNIT-III Algorithms for ANN:** Activation and Synaptic Dynamics, Stability and Convergence. A Survey of Neural Network Models : Single-layered Perceptron – least mean square algorithm, Multi-layered Perceptrons – Back propagation Algorithm, XOR – Problem, The generalized Delta rule, BPN Applications, Adalines and Madalines – Algorithm and applications.

### UNIT-IV

**Applications:** The Traveling salesperson problem, Talking Network and Phonetic typewriter : Speech Generation and Speech recognition, Character Recognition and Retrieval, Handwritten Digit recognition.

### UNIT-V

**Adaptive Fuzzy Systems:** Introduction to Fuzzy sets and operations, Examples of Fuzzy logic, Fuzzy Associative memories, Fuzziness in neural networks, Comparison of Fuzzy and neural Truck-Backer upper control systems.

### SUGGESTED BOOKS & REFERENCE:-

1. *Artificial Neural Networks* by B. Yagna Narayan, PHI



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Sub Code	L	T	P	Duration	IA	ESE	Credits
EC8TPC14	3	1		3 hours	40	60	4

## **RADAR & SATELLITE COMMUNICATION**

**Course Objectives:** Student will try to learn:

1. The fundamentals of satellite communication.
2. To provide them with a sound understanding of how a satellite communication system successfully transfers information from one earth station to another.
3. Working principle of different RADAR systems and their applications.

### **UNIT – I**

**INTRODUCTION:** Origin and brief history of satellite communication; Element of satellite communication link; Current status of satellite communication.

**ORBITAL MECHANISM AND LAUNCHING OF SATELLITE:** Equation of orbit. Describing the orbit, Look angle determination, Azimuth and elevation calculation, Geostationary and other orbit, Orbital perturbation, Orbit determination, Mechanic's of launching a synchronous satellite, selecting a launch vehicle.

### **UNIT – II**

**SPACECRAFT:** Satellite subsystem, power supply altitude and orbit control system, Telemetry and Command, Thermal control system communication subsystem, Space craft antennas, Frequency re-use antennas.

### **UNIT – III**

**SATELLITE CHANNEL & LINK DESIGN:** Basic transmission theory, Noise temperature, Calculation of system noise temperature. Noise figure, G/T Ratio of earth station, Design of down and uplink using C/N ratio, FM improvement factor for multi channel signal, Link design for FDM/FM, TV signal and Digital signals.

### **UNIT – IV**

**MULTIPLE ACCESS TECHNIQUES & EARTH STATION TECHNOLOGY:** Frequency Division Multiple Access (FDMA), FDM/FM/FDMA, Time Division Multiple Access, Frame structure and synchronization, Code Division Multiple Access, Space qualification and Equipment Reliability, random Access, Earth station design requirement, earth station subsystem, Monitoring and control, Antenna noise temperature, Tracking, Design of



**ELECTRONICS & COMMUNICATION ENGINEERING**

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Sub Code	L	T	P	Duration	IA	ESE	Credits
EC8TPC15	3	1		3 hours	40	60	4

## OPTICAL FIBER COMMUNICATION

**Course Objectives:** Students will try to learn:

1. The basics of signal propagation through optical fibers,
2. Study about fiber impairments, components and devices and system design.

### UNIT – I

Introduction to optical communication, Principles of light transmission, optical fiber modes and configurations, mode theory for circular wave-guides, single-mode fibers, multimode fibers, numerical aperture, mode field diameter, V-number, fiber materials, fiber fabrication techniques.

### UNIT – II

Optical sources, LED's, LASER diodes, Model reflection noise, Power launching and coupling, Population Inversion, Fiber Splicing, Optical connector, Photo detector, PIN, Avalanche detector, response time, avalanche multiplication noise.

### UNIT – III

Signal degradation in optical fibers, attenuation losses, signal distortion in optical waveguides, material dispersion, wave guide dispersion, chromatic dispersion, inter-modal distortion, Pulse broadening in graded index fiber, mode coupling, advanced fiber designs: dispersion shifted, dispersion flattened, dispersion compensating fibers, design optimization of single mode fibers.

### UNIT – IV

Coherent optical fiber communication, modulation techniques for homodyne and heterodyne system, optical fiber link design, Rise time budget and link power budget long haul systems, bit error rate, line coding, NRZ, RZ, Block codes, eye pattern.

### UNIT – V

Advanced system and techniques, wavelength division multiplexing, optical amplifiers, semiconductor amplifier, EDFA, Comparison between semiconductor and optical amplifier, Gain bandwidth, photonic switching, optical networks, optical fiber bus, ring topology, star architecture, FDDI.





Sub Code	L	T	P	Duration	IA	ESE	Credits
EC8TPE07	3			3 hours	40	60	3

## VLSI Fabrication Methodology

**CourseObjective:** Student will try to learn:

- 1.The basic MOS Circuits
2. the MOS Process Technology.
3. To understand the operation of MOS devices.
- 4.To impart in-depth knowledge about analog and digital CMOS circuits.

### Unit 1

Introduction, Processing steps of BJT, Processing steps of MOSFET, Control of threshold voltage of MOS, Ion implantation, CVD, Patterning of polysilicon by etching, Self aligned technology, Advantage of polysilicon and problems of metal gate process.

### Unit 2

Si structure, Packing density, Hard sphere model, Mismatch with dopant atom & Misfit factor, Concept of different crystal planes of Si, Natural cleavage plane, Self limiting etching or V-groove etching. Crystal defects- Point, Dislocation, Volume defects

### Unit 3

Si crystal growth by Reduction process, Bridgmann Process, Czochralski Technique, Control of defects in crystal, Zone Refining, Gettering process.

### Unit 4

Si Epitaxy, 3 cardinal rule of hetero-epitaxy, Liquid Phase Epitaxy, Vapor Phase Epitaxy, Problems of VPE, Tilted sample holder, Reactor configuration, Optimization of temperature and pressure, LPCVD from Silicon epitaxy by Silane route, Surface catalysed reaction, Efficiency of deposition, Problems of Silane route.

### Unit 5

Doping during Epitaxy, Autodoping, Junction shift, Pattern shift and distortion, Molecular Beam Epitaxy, Insitu cleaning, Oxidation, Kinetics of oxidation

### SUGGESTED BOOKS & REFERENCE:-

1. VLSI Fabrication Principles by S K Ghandhi,
2. VLSI Technologved S M Sze,
3. Silicon VLSI Technology by J D Plummer, M Deal, P D Griffin



ELECTRONICS & COMMUNICATION ENGINEERING

Effective From 2018-19 (CBCS)

Sub Code	L	T	P	Duration	IA	ESE	Credits
EC8TOE41	3			3 hours	40	60	3

### Basic Building Blocks of Microwave Engineering

**CourseObjective:** Student will try to learn

1. Rectangular and circular wave guides using field theory.
2. The theoretical principles underlying microwave devices and networks.
3. To design microwave components such as power dividers, hybrid junctions, Directional Couplers, microwave filters, Microwave Wave-guides and Components, Ferrite Devices.
4. about Microwave Solid-State Microwave Devices and Microwave Tubes.
5. about Microwave Measurement Techniques.

**Unit 1:** Concept of Mode, TEM, TE, TM and Impedance concept. Loss associated with microwave transmission –Coaxial line, Rectangular waveguide, Circular waveguide, Planar transmission line.

**Unit2:** Challenges of Microwave design-Smith Chart (1<sup>st</sup> tool), Measurement of unknown impedances, Need of impedance matching at Microwave frequencies, Lumped element based impedance matching network by Smith Chart, Distributed impedance matching by Smith Chart, Broadband impedance matching network.

**Unit 3:** Voltage and current at microwave frequency, Scattering parameter (2<sup>nd</sup> tool) Properties of scattering parameter, Network analyser, Problem solving by equivalent voltage and current in waveguide and on scattering parameters.

**Unit 4:** Coaxial connectors, Microwave power divider and combiner, Microwave Resonators, Attenuators, Switching diode.

**Unit 5:** Microwave tubes, Microwave solid state diode oscillators, and Amplifiers, Microwave transistors

#### **SUGGESTED BOOKS & REFERENCE:-**

1. *Microwave Engineering*, David M Pozar,
2. *Microwave Devices & Circuits*, Samuel Y Liao,
3. *Antenna Theory*, C A Balanis

**CourseOutcome :** After completion of course, the student will be able to understand :

1. Integrating a wide range of Microwave components into one design oriented frame work
2. Design and solve real world problems
3. Characterize microwave devices in terms of the directionality of communication.
4. Use a microwave test bench in analyzing various types of microwave measurements.



**ELECTRONICS & COMMUNICATION ENGINEERING**

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Sub Code	L	T	P	Duration	IA	ESE	Credits
EC8TOE42	3			3 hours	40	60	3

**PRINCIPLE OF MANAGEMENT**

**Course Objectives:** Student will try to learn:

1. The functions and responsibilities of managers.
2. To provide them tools and techniques to be used in the performance of the managerial job.
3. To enable them to analyze and understand the environment of the organization.
4. To help the students to develop cognizance of the importance of management principles.

**UNIT – I Management** concepts, Nature, Scope, Significance, Function and Principle of Management Concepts.

Evolution of Management: Early Contribution, Taylor and Scientific management, Fayol's administrative management, Bureaucracy, Hawthorne Experiments and Human Relations.

**UNIT – II**

Planning- Concepts, Objectives, Goals, Components and Steps involved in planning process, MBO, Decision making process, Individual and Group Decision Making.

**UNIT – III**

Organizing- principles, Organization theories, Line & Staff Authority, Centralization, Decentralization, Delegation, Employee's empowerment, Span of control, Departmentation, Authority and Responsibility.

**UNIT – IV**

Staffing: Recruitment & Selection, Training & Development, Performance Appraisal Directing: Concept, Direction and Supervision, Co-ordination.

**UNIT – V**

Communication: Communication Process, Importance of Communication, Barriers to Communication, Controlling: nature, scope, functions, steps and process, control techniques.

**SUGGESTED BOOKS & REFERENCE:**

1. *Management, Stoner & Freeman, PHI*
2. *Principles of Management, Koontz, O'Donnell Wehrich, McGraw Hill*
3. *The Practice of Management, P F Drucker, Allied Pub*
4. *Essentials of Management, Massie, AITBS*
5. *Principles of Management, Terry and Franklin, AITBS*
6. *Organization and Management, R D Agarwal, TMH*



**ELECTRONICS & COMMUNICATION ENGINEERING**

Effective From 2018-19 (CBCS)

Sub Code	L	T	P	Duration	IA	ESE	Credits
EC8TOE43	3			3 hours	40	60	3

## MOBILE COMPUTING

**CourseObjective:** Studentwill try to learn:

- 1.About the concepts and principles of mobile computing;
- 2.To explore both theoretical and practical issues of mobile computing.
3. To develop skills of finding solutions and building software for mobile computing applications.

### UNIT – I

Introduction, issues in mobile computing, overview of wireless telephony: cellular concept, GSM: air-interface, channel structure, location management: HLR-VLR, Hierarchical, handoffs, channel allocation in cellular systems, CDMA, GPRS.

### UNIT –II

Wireless Networking, Wireless LAN Overview: MAC issues, IEEE 802.11, Blue Tooth, Wireless multiple access protocols, TCP over wireless, Wireless applications, data broadcasting, Mobile IP, WAP: Architecture, protocol stack, application environment, applications.

### UNIT –III

Data management issues, data replication for mobile computers, adaptive clustering for mobile wireless networks, File system, Disconnected operations.

### UNIT –IV

Mobile Agents computing, security and fault tolerance, transaction processing in mobile computing environment.

### UNIT –V

Ad Hoc networks, localization, MAC issues, Routing protocols, global state routing (GSR), Destination sequenced distance vector routing (DSDV), Dynamic source routing (DSR), Ad Hoc on demand distance vector routing (AODV), Temporary ordered routing algorithm (TORA), QoS in Ad Hoc Networks, applications.





**ELECTRONICS & COMMUNICATION ENGINEERING**

Effective From 2018-19 (CBCS)

<b>EC8TOE44</b>	<b>3</b>		<b>3 hours</b>	<b>40</b>	<b>60</b>	<b>3</b>
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## **EMBEDDED SYSTEMS**

**Course Objective:** Student will try to learn:

The modern embedded systems and to show how to understand and program such systems using a concrete platform built around.

**UNIT-I Embedded system Introduction :** Basic idea on system, definition of embedded system, characteristic of Embedded system, Challenges in designing of an embedded system, characterization of embedded system.

**UNIT-II Components of Embedded system :** Difference between microprocessor and microcontroller, Functional building blocks of Embedded systems, processor and controller, Memory, ports and communication devices.

**UNIT-III Methodologies, Life cycle and Modeling:** Software Life cycle, Embedded Life cycle Water Fall Model, Spiral Model, RAD Model and Modeling of Embedded system. Simulation and Emulation.

**UNIT-IV Layers of an Embedded system:** Introduction, Need for Layering, The Middleware Layer, The Application Layer. Introduction to Real Time Operating Systems.

**UNIT-V Networks for Embedded Systems :** Serial Communication RS 232 model, I square Model, CAN and CAN Open, SPI and SCI, USB, HDLC, Parallel Communication Basics PCI interface and PCI X- interface. Device Driver Serial Port and Parallel Port.

### **SUGGESTED BOOKS & REFERENCES: -**

1. H.Kopetz, "Real-Time Systems", Kluwer, 1997.
2. R.Gupta, "Co-synthesis of Hardware and Software for Embedded Systems", Kluwer 1995.

**Course Outcome:** After completion of the course student will be able to:

1. Identify the hardware and software components of an embedded system
2. Choose appropriate embedded system architecture for the given application
3. Write programs for optimized performance of an embedded system and validate



**ELECTRONICS & COMMUNICATION ENGINEERING**

Effective From 2018-19 (CBCS)

Sub Code	L	T	P	Duration	IA	ESE	Credits
EC8TOE45	3			3 hours	40	60	3

### Advanced Power Electronics

**Course Objectives:** Student will try to learn:

1. Selected areas of power electronics in greater depth.
2. Learn recent developments in power electronics.
3. in detail applications of power electronics

**UNIT I Phase Controlled Rectifiers:** Principle of phase control, Single Phase Full wave controlled converters: Midpoint and bridge type, analysis of two pulse bridge converter with continuous current., Single phase two pulse converters with discontinuous current

#### Unit-II

**DC to DC switch mode Regulators:** Introduction, Review of linear power supply and basic dc-dc voltage regulator configurations, Buck converters, Boost converters, Buck-Boost converters and their analysis for continuous and discontinuous conduction mode, other converter configurations.

**Unit-III Resonant Converters:** Introduction, Need of resonant converters, Classification of resonant converters, Load resonant converters, resonant switch converters, Zero Voltage Switching DC-DC Converters, Zero Current Switching DC-DC Converters, Applications Of Resonant Converters.

**Unit-IV Multi-level converters:** Need for multi-level inverters, Concept of multi-level, Topologies for multi-level: Diode Clamped, Cascaded H-bridge multilevel Converters configurations; Features and relative comparison of these configurations applications.

**Unit-V Review of Inverters and Controllers:** Review of single-phase half bridge, full bridge, bipolar, unipolar, VSI and CSI, review of single phase ac to ac controllers, Phase-Controlled Three-Phase AC Voltage Controllers.

#### Text Books:

1. Ned Mohan, Tore M. Undeland and William P. Robbins, "Power Electronics – Converters, Applications and Design", John Willey & sons, Inc., 3rd ed., 2003.
2. Muhammad H. Rashid, "Power Electronics - Circuits, Devices and Applications", Prentice Hall of India, 3rd ed., 2009.
3. Modern Power Electronics and AC Drives –B. K. Bose-Pearson Publications, 2002.
4. L. Umanand, "Power Electronics Essentials and Applications", Wiley India Ltd., 2009